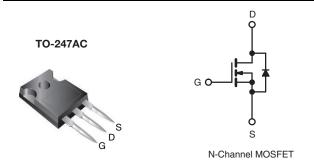


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# **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	600	600				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.21				
Q <sub>g</sub> (Max.) (nC)	180	180				
Q <sub>gs</sub> (nC)	61	61				
Q <sub>gd</sub> (nC)	85	85				
Configuration	Sing	Single				



#### **FEATURES**

· Superfast body diode eliminates the need for external diodes in ZVS applications



• Lower gate charge results in simpler drive requirements

- Enhanced dV/dt capabilities offer improved ruggedness
- · Higher gate voltage threshold offers improved noise immunity
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

## **APPLICATIONS**

- Zero voltage switching (SMPS)
- Telecom and server power supplies
- Uninterruptible power supplies
- Motor control applications

ORDERING INFORMATION			
Package	TO-247AC		
Load (Dh) frag	IRFP26N60LPbF		
Lead (Pb)-free	SiHFP26N60L-E3		
SnPb	IRFP26N60L		
SIPO	SiHFP26N60L		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	600	V
Gate-Source Voltage			$V_{GS}$	± 30	7 v
Continuous Drain Current	V at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	26	
Continuous Drain Current	V <sub>GS</sub> at 10 V	Γ <sub>C</sub> = 100 °C		17	Α
Pulsed Drain Current a			I <sub>DM</sub>	100	
Linear Derating Factor				3.8	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	570	mJ
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	26	Α
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	47	mJ
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	470	W
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	21	V/ns
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Soldering Recommendations (Peak Temperature) d for 10 s				300	7
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in
Mounting Torque				1.1	N · m

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Starting T<sub>J</sub> = 25 °C, L = 1.7 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 26 A, dV/dt = 21 V/ns (see fig. 12). c. I<sub>SD</sub>  $\leq$  26 A, dI/dt  $\leq$  480 A/µs, V<sub>DD</sub>  $\leq$  V<sub>DS</sub>, T<sub>J</sub>  $\leq$  150 °C.

- d. 1.6 mm from case.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.27		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.33	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0	-	5.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 30 V	-	-	± 100	nA
Zava Cata Valtaga Dvais Cuvvant		V <sub>DS</sub> =	= 600 V, V <sub>GS</sub> = 0 V	-	-	50	μΑ
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	2.0	mA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A <sup>b</sup>	-	0.21	0.25	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS}$	= 50 V, I <sub>D</sub> = 16 A	13	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	5020	-	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	450	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>			-	34	-	
Effective Output Capacitance	Coss eff.	V <sub>GS</sub> = 0 V V <sub>DS</sub> = 0 V to 480 V °		-	230	-	
Effective Output Capacitance (Energy related)	C <sub>oss</sub> eff. (ER)			-	170	-	
Total Gate Charge	Qg			-	-	180	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 26 \text{ A, } V_{DS} = 480 \text{ V,}$ see fig. 7 and 15 <sup>b</sup>		-	-	61	nC
Gate-Drain Charge	$Q_{gd}$			-	-	85	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 300 \text{ V, } I_D = 26 \text{ A,} \\ R_g = 4.3 \ \Omega, V_{GS} = 10 \text{ V} \\ \text{see fig. 11a and 11b }^b$		-	31	-	ns
Rise Time	t <sub>r</sub>			-	110	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	47	-	
Fall Time	t <sub>f</sub>			-	42	-	
<b>Drain-Source Body Diode Characteristic</b>	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	26	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	100	
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 26  \text{A},  V_{GS} = 0  \text{V}^{ \text{b}}$		-	-	1.5	V
Dada Diada Damara Daga Tiran		T <sub>J</sub> = 25 °C, I <sub>F</sub> = 26 A		-	170	250	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C, dI/dt = 100 A/μs b		-	210	320	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = 26 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$ $T_J = 125 ^{\circ}\text{C}, dI/dt = 100 \text{A/µs}^{\text{b}}$		-	670 1050	1000 1570	nC
Reverse Recovery Current	I <sub>RRM</sub>	T <sub>1</sub> = 25 °C		-	7.3	11	Α
Forward Turn-On Time	t <sub>on</sub>	Late de la de	ı-on is dor			1	

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$
- c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .  $C_{oss}$  eff. (ER) is a fixed capacitance that stores the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

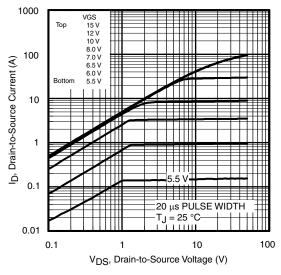


Fig. 1 - Typical Output Characteristics

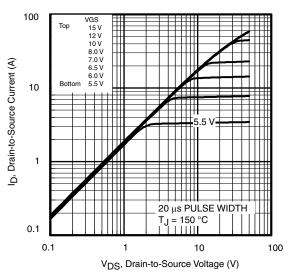


Fig. 2 - Typical Output Characteristics

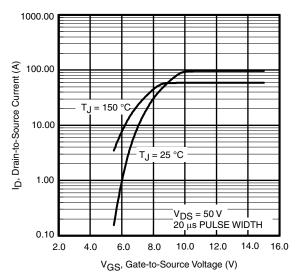


Fig. 3 - Typical Transfer Characteristics

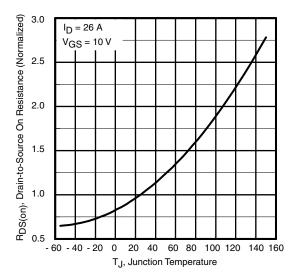


Fig. 4 - Normalized On-Resistance vs. Temperature



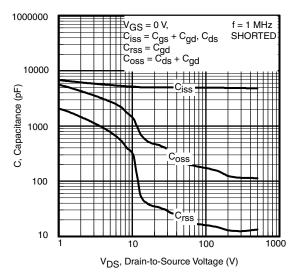


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

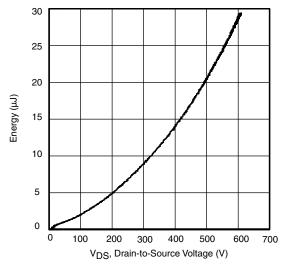


Fig. 6 - Typical Output Capacitance Stored Energy vs.V<sub>DS</sub>

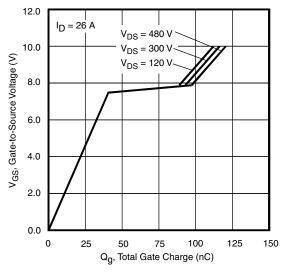


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

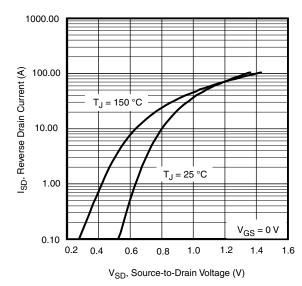


Fig. 8 - Typical Source-Drain Diode Forward Voltage



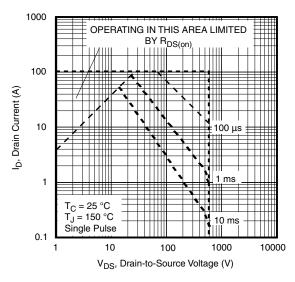


Fig. 9 - Maximum Safe Operating Area

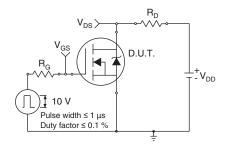


Fig. 11a - Switching Time Test Circuit

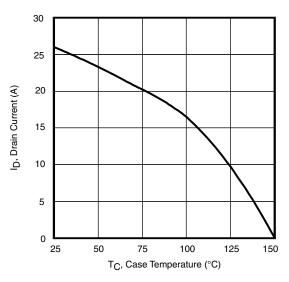


Fig. 10 - Maximum Drain Current vs. Case Temperature

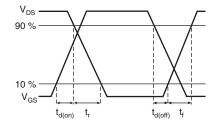


Fig. 11b - Switching Time Waveforms

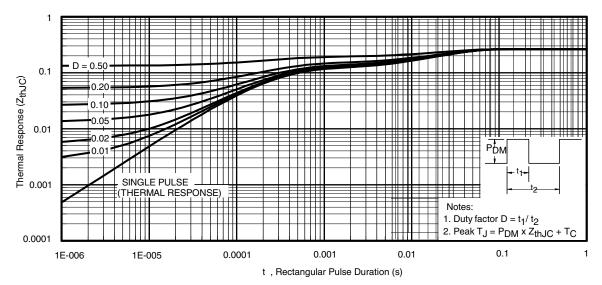


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

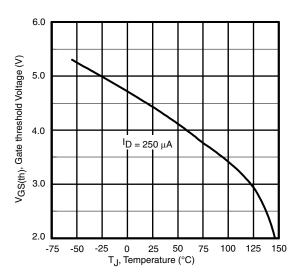


Fig. 13 - Threshold Voltage vs. Temperature

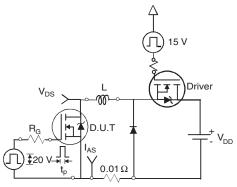


Fig. 14a - Unclamped Inductive Test Circuit

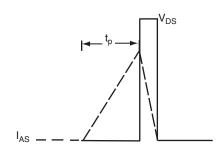


Fig. 14b - Unclamped Inductive Waveforms

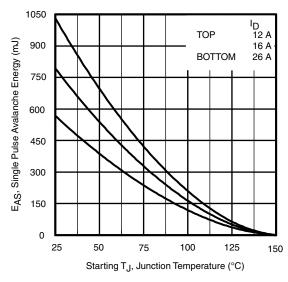


Fig. 14c - Maximum Avalanche Energy vs. Drain Current

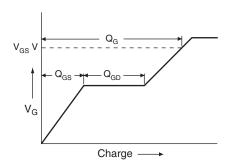


Fig. 15a - Basic Gate Charge Waveform

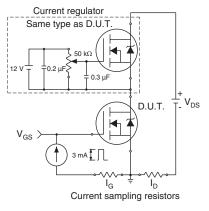
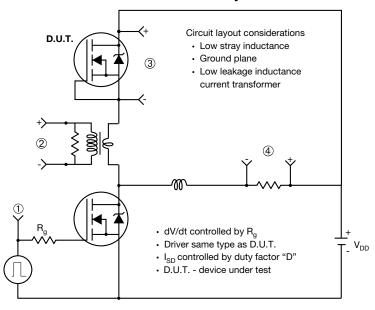


Fig. 15b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



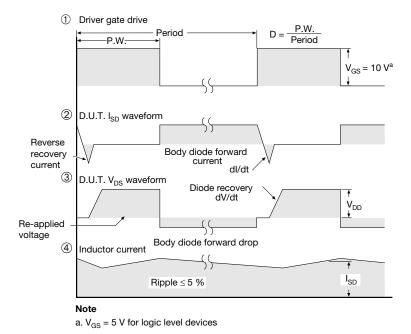
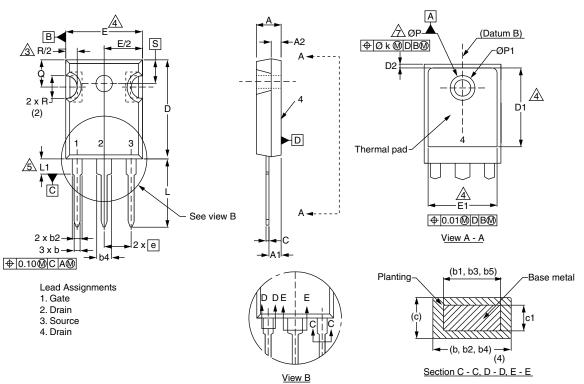


Fig. 16 - For N-Channel

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# **TO-247AC (High Voltage)**



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.58	5.31	0.180	0.209
A1	2.21	2.59	0.087	0.102
A2	1.17	2.49	0.046	0.098
b	0.99	1.40	0.039	0.055
b1	0.99	1.35	0.039	0.053
b2	1.53	2.39	0.060	0.094
b3	1.65	2.37	0.065	0.093
b4	2.42	3.43	0.095	0.135
b5	2.59	3.38	0.102	0.133
С	0.38	0.86	0.015	0.034
c1	0.38	0.76	0.015	0.030
D	19.71	20.82	0.776	0.820
D1	13.08	-	0.515	-

	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	
E1	13.72	ı	0.540	ı	
е	5.46	BSC	0.215 BSC		
Øk	0.2	0.254		0.010	
L	14.20	16.25	0.559	0.640	
L1	3.71	4.29	0.146	0.169	
N	7.62	7.62 BSC		BSC	
ØΡ	3.51	3.66	0.138	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		
0.217 800					

ECN: X13-0103-Rev. D, 01-Jul-13

DWG: 5971

### **Notes**

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Contour of slot optional.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions D1 and E1.
  5. Lead finish uncontrolled in L1.
- 6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").
- 7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.
- 8. Xian and Mingxin actually photo.





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Revision: 13-Jun-16 1 Document Number: 91000

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